# onsemi

MARKING

# Negative Voltage SPDT Switch

# **NLHV4157N**

The NLHV4157N is an advanced CMOS analog switch fabricated with silicon gate CMOS technology. The device passes analog and digital negative voltages that may vary across the full power–supply range (from  $V_{EE}$  to GND).

## Features

- Operating Voltage Range:  $V_{EE} = -12 \text{ V to } -4 \text{ V}$
- Switch Signal Voltage Range:  $V_{IS} = V_{EE}$  to GND
- Positive Control Signal Voltage:  $V_{IN} = 0$  to 3.3 V
- Low ON Resistance:  $R_{ON} \le 5 \Omega$  @  $V_{EE} = -10 V$
- Latch-up Performance Exceeds 200 mA
- Available in: SC-88 6-Pin Package
- These Devices are Pb–Free, Halogen–Free/BFR-Free and are RoHS–Compliant

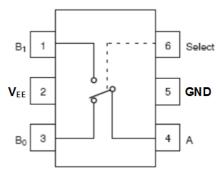
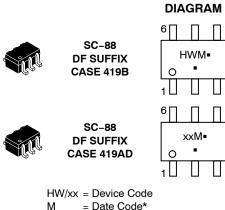


Figure 1. Pin Assignment and logic Diagram



M = Date Code\*
= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

### FUNCTION TABLE

Select	Input	Function
L		B0 Connected to A
Н		B1 Connected to A

### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### **ORDERING INFORMATION**

Device	Marking	Package	Case Code	Shipping <sup>†</sup>
NLHV4157NDFT2G	HW	SC-88	419B	3000 / Tape & Reel
NLHV4157NSDFT2G (In Development, please contact <b>onsemi</b> )	XX	SC-88	419AD	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **MAXIMUM RATINGS**

Symbol	Rati	ng	Value	Unit
$V_{EE}$	DC Supply Voltage		-13 to +0.5	V
V <sub>IS</sub>	Analog Input Voltage (Note 1)		V <sub>EE</sub> -0.5 to +0.5	V
V <sub>IN</sub>	Digital Select Input Voltage (Note 1)		-0.5 to +3.6	V
I <sub>IOK</sub>	Switch Input/Output diode current		±50	mA
Ι <sub>ικ</sub>	Select input diode current	-50	mA	
PD	Power Dissipation in Still Air	60	mW	
TL	Lead Temperature, 1 mm from Case for	260	°C	
TJ	Junction Bias Under Bias		150	°C
MSL	Moisture Sensitivity		Level 1	
F <sub>R</sub>	Flammability Rating	Oxygen Index: 30% – 35%	UL94–V0 (0.125 in)	°C
١L	Latch-up Current (Note1)	Below GND and above $V_{\mbox{\scriptsize EE}}$ at 125°C	±200	mA
		Below GND and above V <sub>EE</sub> at 25°C	±300	
Ts	Storage Temperature		-65 to +150	°C
$\theta_{JA}$	Thermal Resistance		400	°C/W
ESD	ESD Protection	Human Body Model	3000	V
		Machine Model	150	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The input and output voltage ratings may be exceeded if the input and output diode current ratings are observed.

#### **RECOMMENDED OPERATING CONDITIONS** (Note 2)

Symbol	Parameter	Min	Max	Unit
V <sub>EE</sub>	DC Supply Voltage	-12	-4	V
VS	Switch Input / Output Voltage (B0, B1, A)	V <sub>EE</sub>	GND	V
V <sub>IN</sub>	Digital Select Input Voltage	GND	3.3	V
T <sub>A</sub>	Operating Temperature Range	-55	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Transition Rise or Fall Time (Select Input)	0	100	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 2. Select input must be held HIGH or LOW, it must not float.

#### DC ELECTRICAL CHARACTERISTICS (Voltages referenced to GND; Typical characteristics are T<sub>A</sub> at 25°C.)

				–55° to 125°C			
Symbol	Parameter	Condition	V <sub>EE</sub> , V	Min	Тур	Max	Uni
SELECT IN	PUT	•			•		
VIH	Minimum High–Level		-12	1.8		3.3	V
	Input Voltage		-10	1.6		3.3	
			-8	1.4		3.3	
			-6	1.2		3.3	
			-4	1.0		3.3	
VIL	Maximum Low-Level		-12	0		0.8	V
	Input Voltage		-10	0		0.7	
			-8	0		0.6	
			-6	0		0.5	
			-4	0		0.4	
I <sub>IN</sub>	Maximum Input Leakage	V <sub>IN</sub> = 3.3 V or GND	-10		±0.2	±50	μ
	Current	V <sub>IN</sub> = 3.3 V or GND, test at 25°C only	-10			±0.5	
OWER SL	IPPLY				8		
I <sub>CC</sub>	Maximum Quiescent Supply Current	Select = 3.3 V or GND, V <sub>IS</sub> = V <sub>EE</sub> or GND	–10 to –4		25	80	μ
ANALOG S	WITCH				8		
R <sub>ON</sub> Maximum ON Resistance (Note 3)	Maximum ON	$V_{IN} = V_{IL} \text{ or } V_{IH}$	-12		2.6	4.5	S
	$V_{IS} = V_{EE}$ to GND $I_O \le 10 \text{ mA}$	-10		3.0	5	1	
	$10 \ge 10 \text{ IIIA}$	-8		3.5	5.8		
			-6		4.5	7.5	
		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $V_{IS} = V_{EE} \text{ to GND}$ $I_O \le 5 \text{ mA}$	-4		9	15	
R <sub>FLAT</sub>	ON Resistance	$V_{IN} = V_{IL}$ or $V_{IH}$	-12		0.4		Ω
	Flatness (Notes 3, 4, 6)	$V_{IS} = V_{EE}$ to GND $I_O \le 10 \text{ mA}$	-10		1.2		
			-8		1.7		
			-6		2.5		
		$V_{IN} = V_{IL} \text{ or } V_{IH}$ $V_{IS} = V_{EE} \text{ to GND}$ $I_O \le 5 \text{ mA}$	-4		6		
$\Delta R_{ON}$	R <sub>ON</sub> Mismatch	I <sub>A</sub> = -10 mA, V <sub>Bn</sub> = -8.4 V	-12		0.2		<u>C</u>
	Between (Notes 3, 4, 5)	I <sub>A</sub> = -10 mA, V <sub>Bn</sub> = -7 V	-10		0.2		
		I <sub>A</sub> = -10 mA, V <sub>Bn</sub> = -5.6 V	-8		0.25		
		I <sub>A</sub> = -10 mA, V <sub>Bn</sub> = -4.2 V	-6		0.25		1
		I <sub>A</sub> = -5 mA, V <sub>Bn</sub> = -2.8 V	-4		0.3		1
I <sub>NC(OFF)</sub> , I <sub>NO(OFF)</sub>	NC or NO OFF Leakage Current (Figure 9)	$V_{IN} = V_{IL}$ or $V_{IH}$ , $V_{Bn} = GND$ , $V_A = V_{EE}$ to GND	-10		±1.0	±20	μ
I <sub>COM(ON)</sub>	COM ON Leakage Current (Figure 9)		-10		±2.0	±20	μ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower

of the voltages on the two (A or B Ports).4. Parameter is characterized but not tested in production.

5.  $\Delta R_{ON} = R_{ON}max - R_{ON}min$  measured at identical V<sub>EE</sub>, temperature and voltage levels. 6. Flatness is defined as the difference between the maximum and minimum value of ON Resistance over the specified range of conditions.

				-	–55° to 125°C		
Symbol	Parameter	Condition	V <sub>EE</sub> , V	Min	Тур	Max	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay, Bus to Bus (Note 8) (A to B <sub>n</sub> )	C <sub>L</sub> = 100 pF (Figures 2, 3)	-12 to -4			2	ns
t <sub>PZL</sub> , t <sub>PZH</sub>	Switch Enable Time	C <sub>L</sub> = 100 pF (Figures 2, 3)	-12			220	ns
	Turn–On Time		-10			175	
	(A to B <sub>n</sub> )		-8			165	
			-6			165	
		-4			200		
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Switch Disable Time	C <sub>L</sub> = 100 pF (Figures 2, 3)	-12			225	ns
	Turn–Off Time (A to B <sub>n</sub> )		-10			155	
	(A to B <sub>n</sub> )		-8			150	
		-6			120		
		-4			145		
t <sub>B</sub>	Switch Break Time $R_L = 50 \Omega, C_L = 100 pF,$	-12	5		60	ns	
		$V_{IS} = -2.5 V (Figure 4)$	-10	5		60	
			-8	10		75	
			-6	10		90	
			-4	40		135	
t <sub>POR</sub>	Power ON Reset Time	Measured from $V_{EE} = -4 V$	–12 to –4			20	μs
Q	Charge Injection	$C_L = 1 \text{ nF}, V_{GEN} = 0 \text{ V},$	-12		170		рС
	(Note 7)	$R_{GEN} = 0 \Omega$ (Figure 5)	-10		120		
			-8		95		
			-6		55		
			-4		40		
OIRR	Off-Isolation (Note 9)	$R_L = 50 \Omega$ , f = 10 MHz (Figure 6)	–12 to –4		-33		dB
Xtalk	Crosstalk	$R_L$ = 50 $\Omega$ , f = 10 MHz (Figure 7)	–12 to –4		-42		dB
BW	-3 dB Bandwidth	$R_L = 50 \Omega$ (Figure 10)	–12 to –4		200		MHz

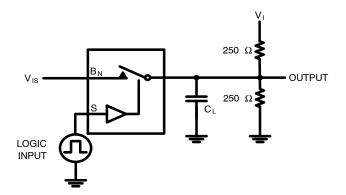
# AC ELECTRICAL CHARACTERISTICS (Voltages referenced to GND; Typical characteristics are T<sub>A</sub> at 25°C.)

Guaranteed by Design.
This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the ON Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).
Off Isolation = 20 log10 [VA/VBn].

### CAPACITANCES (Note 10)

Symbol	Parameter	Test Conditions	Typical @ 25°C	Unit
C <sub>IN</sub>	Input Capacitance, Select Inputs	V <sub>EE</sub> = -12 V	6	pF
C <sub>IOB</sub>	B-Port OFF Capacitance	V <sub>EE</sub> = -10 V	45	pF
C <sub>IOA_ON</sub>	A Port Capacitance when Switch is Enabled	V <sub>EE</sub> = -10 V	100	pF

 $10. T_A = +25^{\circ}C$ , f = 1 MHz, Capacitance is characterized but not tested in production.



Note: Input V<sub>IS</sub> driven by 50  $\Omega$  source terminated by 50  $\Omega$ . Note: C<sub>L</sub> includes load and stray capacitance. Input PRR = 100 kHz, t<sub>W</sub> = 5  $\mu$ s.

Parameter	VI	V <sub>IS</sub>
t <sub>PLH</sub> / t <sub>PHL</sub>	Open	Source
t <sub>PZL</sub> / t <sub>PLZ</sub>	GND	V <sub>EE</sub>
t <sub>PZH</sub> / t <sub>PHZ</sub>	2 x V <sub>EE</sub>	GND

Figure 2. AC Test Circuit

t<sub>r</sub> = 2.5 ns - — — 1.8 V

GND

V<sub>oL</sub> + 0.3 V

V<sub>он</sub> - 0.3 V

Vol

Vor

VTRI

90%

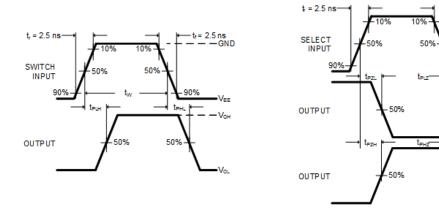


Figure 3. AC Test Waveforms

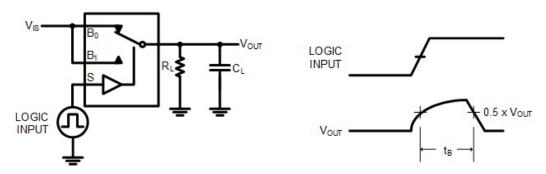
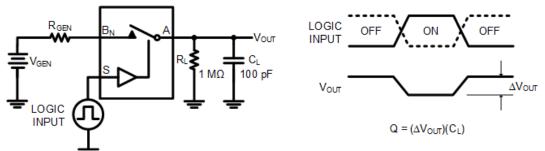
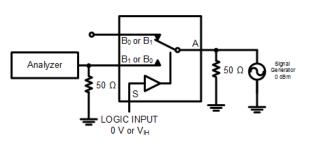
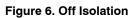


Figure 4. Switch Break Interval Timing









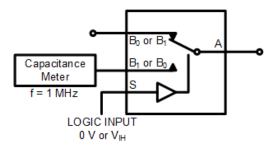
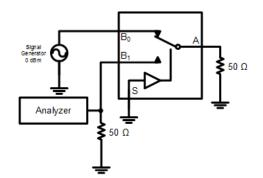


Figure 8. Channel Off Capacitance





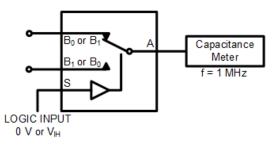


Figure 9. Channel On Capacitance

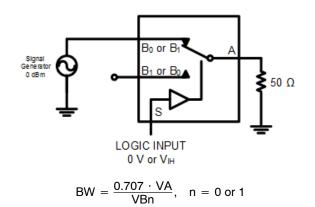
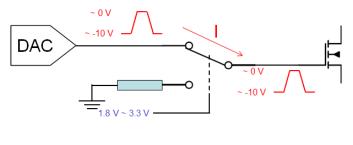


Figure 10. Bandwidth



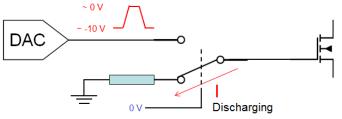
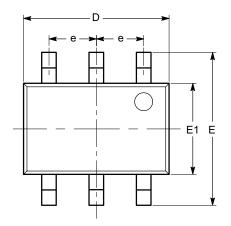


Figure 11. Typical Application

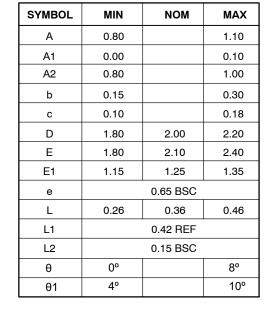
## PACKAGE DIMENSIONS

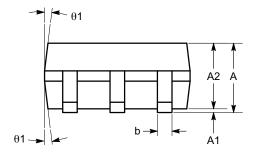
# SC-88 (SC-70 6 Lead), 1.25x2 CASE 419AD







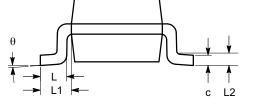




SIDE VIEW

#### Notes:

All dimensions are in millimeters. Angles in degrees.
Complies with JEDEC MO-203.

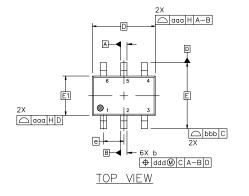




#### SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02 **ISSUE Z**

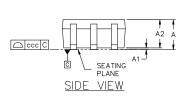
#### DATE 18 APR 2024

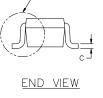
DUSEM



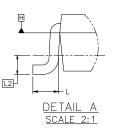
# NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME 1. Y14.5-2018.
- 2.
- ALL DIMENSION ARE IN MILLIMETERS. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 3. PER END.
- 4. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF DATUMS A AND B ARE DETERMINED AT DATUM H.
- 5.
- DIMENSIONS & AND C APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP. 6.
- DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. 7 ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION & AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

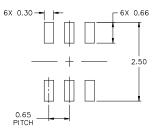




DETAIL A



	MI	MILLIMETERS			
DIM	MIN.	NOM.	MAX.		
A			1.10		
A1	0.00		0.10		
A2	0.70	0.90	1.00		
b	0.15	0.20	0.25		
с	0.08	0.15	0.22		
D	2.00 BSC				
E	2.10 BSC				
E1		1.25 BSC	;		
е		0.65 BSC	)		
L	0.26	0.36	0.46		
L2		0.15 BSC			
aaa	0.15				
bbb	0.30				
ccc	0.10				
ddd		0.10			



RECOMMENDED MOUNTING FOOTPRINT\*

FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

XXX = Specific Device Code = Date Code\* Μ

GENERIC **MARKING DIAGRAM\*** 

XXXM-

0

6

= Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

## **STYLES ON PAGE 2**

DOCUMENT NUMBER:	98ASB42985B	Electronic versions are uncontrolled except when accessed directly from the Document Reposi Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	: SC-88 2.00x1.25x0.90, 0.65P		PAGE 1 OF 2		
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#### SC-88 2.00x1.25x0.90, 0.65P CASE 419B-02 ISSUE Z

#### DATE 18 APR 2024

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

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